Cypress Semiconductor Corp - MB90387SPMT-GS-119 Datasheet

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, SCI, UART/USART
Peripherals	POR, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90387spmt-gs-119

10. I/O Map

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
000000H	(Reserved area) *				
000001H	PDR1	Port 1 data register	R/W	Port 1	XXXXXXXXB
000002H	PDR2	Port 2 data register	R/W	Port 2	XXXXXXXXB
000003H	PDR3	Port 3 data register	R/W	Port 3	XXXXXXXXB
000004H	PDR4	Port 4 data register	R/W	Port 4	XXXXXXXXB
000005H	PDR5	Port 5 data register	R/W	Port 5	XXXXXXXXB
000006H to 000010H	(Reserved area) *				
000011H	DDR1	Port 1 direction data register	R/W	Port 1	00000000B
000012H	DDR2	Port 2 direction data register	R/W	Port 2	00000000B
000013H	DDR3	Port 3 direction data register	R/W	Port 3	000X0000B
000014H	DDR4	Port 4 direction data register	R/W	Port 4	XXX00000B
000015H	DDR5	Port 5 direction data register	R/W	Port 5	00000000B
000016H to 00001AH	(Reserved area) *				
00001BH	ADER	Analog input permission register	R/W	8/10-bit A/D converter	11111111B
00001CH to 000025H	(Reserved area) *				
000026H	SMR1	Serial mode register 1	R/W	UART1	00000000B
000027H	SCR1	Serial control register 1	R/W, W		00000100B
000028H	SIDR1/ SODR1	Serial input data register 1/ Serial output data register 1	R, W		XXXXXXXXB
000029H	SSR1	Serial status data register 1	R, R/W		00001000B
00002AH	(Reserved area) *				
00002BH	CDCR1	Communication prescaler control register 1	R/W	UART1	0XXX0000B
00002CH to 00002FH	(Reserved area) *				
000030H	ENIR	DTP/External interrupt permission register	R/W	DTP/External interrupt	00000000B
000031H	EIRR	DTP/External interrupt permission register	R/W		XXXXXXXXB
000032H	ELVR	Detection level setting register	R/W		00000000B
000033H			R/W		00000000B
000034H	ADCS	A/D control status register	R/W	8/10-bit A/D converter	00000000B
000035H			R/W, W		00000000B
000036H	ADCR	A/D data register	W, R		XXXXXXXXB
000037H			R		00101XXXB

11. Interrupt Sources, Interrupt Vectors, And Interrupt Control Registers

Interrupt Source	EI²OS Readiness	Interrupt Vector			Interrupt Control Register		Priority*3
		Number		Address	ICR	Address	
Reset	×	#08	08H	FFFFDCH	–	–	High
INT 9 instruction	×	#09	09H	FFFFD8H	–	–	↑
Exceptional treatment	×	#10	0AH	FFFFD4H	–	–	
CAN controller reception completed (RX)	´	#11	0BH	FFFFD0H	ICR00	0000B0H*1	
CAN controller transmission completed (TX) / Node status transition (NS)	´	#12	0CH	FFFFCCH			
Reserved	×	#13	0DH	FFFFC8H	ICR01	0000B1H	
Reserved	×	#14	0EH	FFFFC4H			
CAN wakeup	Δ	#15	0FH	FFFFC0H	ICR02	0000B2H*1	
Time-base timer	×	#16	10H	FFFFBCH			
16-bit reload timer 0	Δ	#17	11H	FFFFB8H	ICR03	0000B3H*1	
8/10-bit A/D converter	Δ	#18	12H	FFFFB4H			
16-bit free-run timer overflow	Δ	#19	13H	FFFFB0H	ICR04	0000B4H*1	
Reserved	×	#20	14H	FFFFACH			
Reserved	×	#21	15H	FFFFA8H	ICR05	0000B5H*1	
PPG timer ch0, ch1 underflow	´	#22	16H	FFFFA4H			
Input capture 0-input	Δ	#23	17H	FFFFA0H	ICR06	0000B6H*1	
External interrupt (INT4/INT5)	Δ	#24	18H	FFFF9CH			
Input capture 1-input	Δ	#25	19H	FFFF98H	ICR07	0000B7H*2	
PPG timer ch2, ch3 underflow	´	#26	1AH	FFFF94H			
External interrupt (INT6/INT7)	Δ	#27	1BH	FFFF90H	ICR08	0000B8H*1	
Watch timer	Δ	#28	1CH	FFFF8CH			
Reserved	×	#29	1DH	FFFF88H	ICR09	0000B9H*1	
Input capture 2-input Input capture 3-input	´	#30	1EH	FFFF84H			
Reserved	×	#31	1FH	FFFF80H	ICR10	0000BAH*1	
Reserved	×	#32	20H	FFFF7CH			
Reserved	×	#33	21H	FFFF78H	ICR11	0000BBH*1	
Reserved	×	#34	22H	FFFF74H			
Reserved	×	#35	23H	FFFF70H	ICR12	0000BCH*1	↓
16-bit reload timer 1	○	#36	24H	FFFF6CH			Low

Interrupt Source	EI²OS Readiness	Interrupt Vector			Interrupt Control Register		Priority*3
		Number		Address	ICR	Address	
UART1 reception completed	◎	#37	25H	FFFF68H	ICR13	0000BDH*1	High
UART1 transmission completed	Δ	#38	26H	FFFF64H			↑
Reserved	×	#39	27H	FFFF60H	ICR14	0000BEH*1	
Reserved	×	#40	28H	FFFF5CH			
Flash memory	×	#41	29H	FFFF58H	ICR15	0000BFH*1	↓
Delay interrupt generation module	×	#42	2AH	FFFF54H			Low

○ : Available

× : Unavailable

◎ : Available EI²OS function is provided.

Δ: Available when a cause of interrupt sharing a same ICR is not used.

*1:

- ❒ Peripheral functions sharing an ICR register have the same interrupt level.
- ❒ If peripheral functions share an ICR register, only one function is available when using expanded intelligent I/O service.
- ❒ If peripheral functions share an ICR register, a function using expanded intelligent I/O service does not allow interrupt by another function.

*2: Input capture 1 corresponds to EI²OS, however, PPG does not. When using EI²OS by input capture 1, interrupt should be disabled for PPG.

*3:Priority when two or more interrupts of a same level occur simultaneously.

12. Peripheral Resources

12.1 I/O Ports

The I/O ports are used as general-purpose input/output ports (parallel I/O ports). The MB60385 series model is provided with 5 ports (34 inputs). The ports function as input/output pins for peripheral functions also.

I/O Port Functions

An I/O port, using port data resister (PDR), outputs the output data to I/O pin and input a signal input to I/O port. The port direction register (DDR) specifies direction of input/output of I/O pins on a bit-by-bit basis.

The following summarizes functions of the ports and sharing peripheral functions:

■ Port 1: General-purpose input/output port, used also for PPG timer output and input capture inputs.

■ Port 2: General-purpose input/output port, used also for reload timer input/output and external interrupt input.

■ Port 3: General-purpose input/output port, used also for A/D converter activation trigger pin.

■ Port 4: General-purpose input/output port, used also for UART input/output and CAN controller send/receive pin.

■ Port 5: General-purpose input/output port, used also analog input pin.

12.3 Watchdog Timer

The watchdog timer is a 2-bit counter that uses time-base timer or watch timer as count clock. If the counter is not cleared within an interval time, CPU is reset.

Watchdog Timer Functions

- The watchdog timer is a timer counter that prevents runaway of a program. Once a watchdog timer is activated, the counter of watchdog timer must always be cleared within a specified time of interval. If specified interval time elapses without clearing the counter of a watchdog timer, CPU resetting occurs. This is the function of a watchdog timer.
- The interval time of a watchdog timer is determined by a clock cycle, which is input as a count clock. Watchdog resetting occurs between a minimum time and a maximum time specified.
- The output target of a clock source is specified by the watchdog clock selection bit (WTC: WDCS) in the watch timer control register.
- Interval time of a watchdog timer is specified by the time-base timer output selection bit / watch timer output selection bit (WDTC: WT1, WT0) in the watchdog timer control register.

Interval Timer of Watchdog Timer

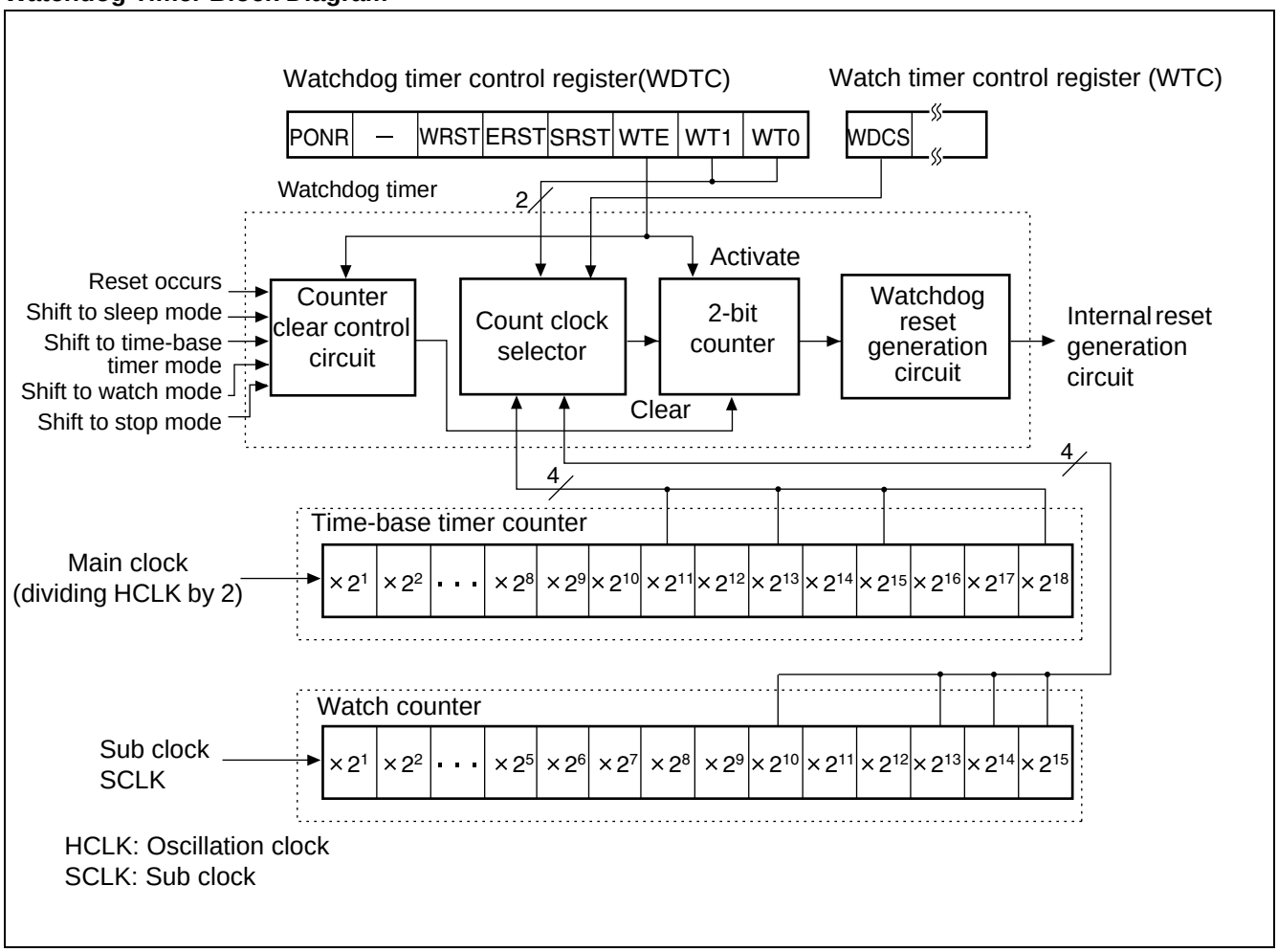
Min	Max	Clock Cycle	Min	Max	Clock Cycle
Approx. 3.58 ms	Approx. 4.61 ms	$(2^{14}\pm2^{11})$ /HCLK	Approx. 0.457 s	Approx. 0.576 s	$(2^{12}\pm2^{9})$ /SCLK
Approx. 14.33 ms	Approx. 18.3 ms	$(2^{16}\pm2^{13})$ /HCLK	Approx. 3.584 s	Approx. 4.608 s	$(2^{15}\pm2^{12})$ /SCLK
Approx. 57.23 ms	Approx. 73.73 ms	$(2^{18}\pm2^{15})$ /HCLK	Approx. 7.168 s	Approx. 9.216 s	$(2^{16}\pm2^{13})$ /SCLK
Approx. 458.75 ms	Approx. 589.82 ms	$(2^{21}\pm2^{18})$ /HCLK	Approx. 14.336 s	Approx. 18.432 s	$(2^{17}\pm2^{14})$ /SCLK

HCLK: Oscillation clock (4 MHz), CSCLK: Sub clock (8.192 kHz)

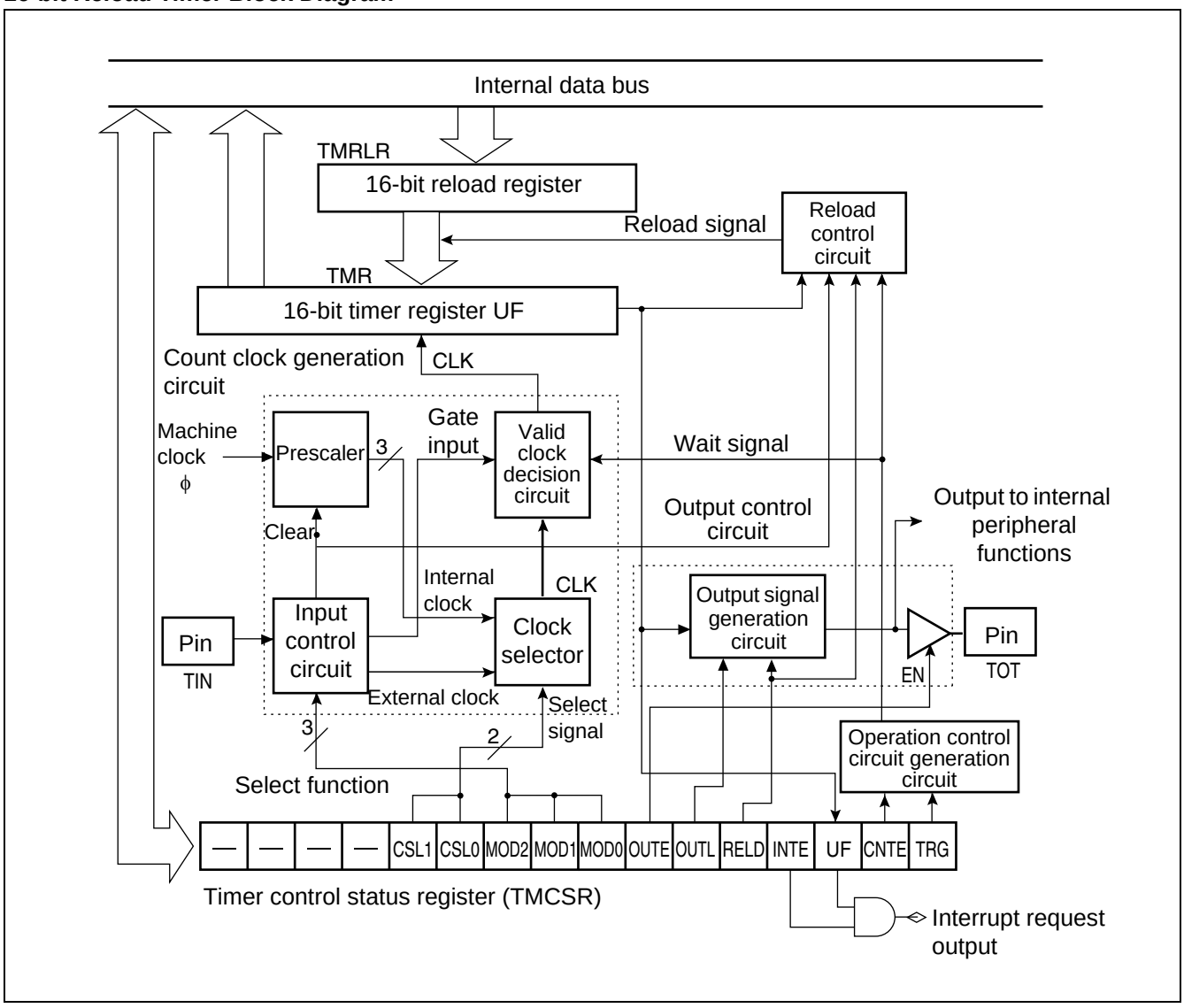
Notes:

- If the time-base timer is cleared when watchdog timer count clock is used as time base timer output (carry-over signal), watchdog reset time may become longer.
- When using the sub clock as machine clock, be sure to specify watchdog timer clock source selection bit (WDCS) in watch timer control register (WTC) at “0,” selecting output of watch timer.

Watchdog Timer Block Diagram



16-bit Reload Timer Block Diagram



12.7 8/16-bit PPG Timer Outline

The 8/16-bit PPG timer is a 2-channel reload timer module (PPG0 and PPG1) that allows outputting pulses of arbitrary cycle and duty cycle. Combination of the two channels allows selection among the following operations:

- 8-bit PPG output 2-channel independent operation mode
- 16-bit PPG output operation mode
- 8-bit and 8-bit PPG output operation mode

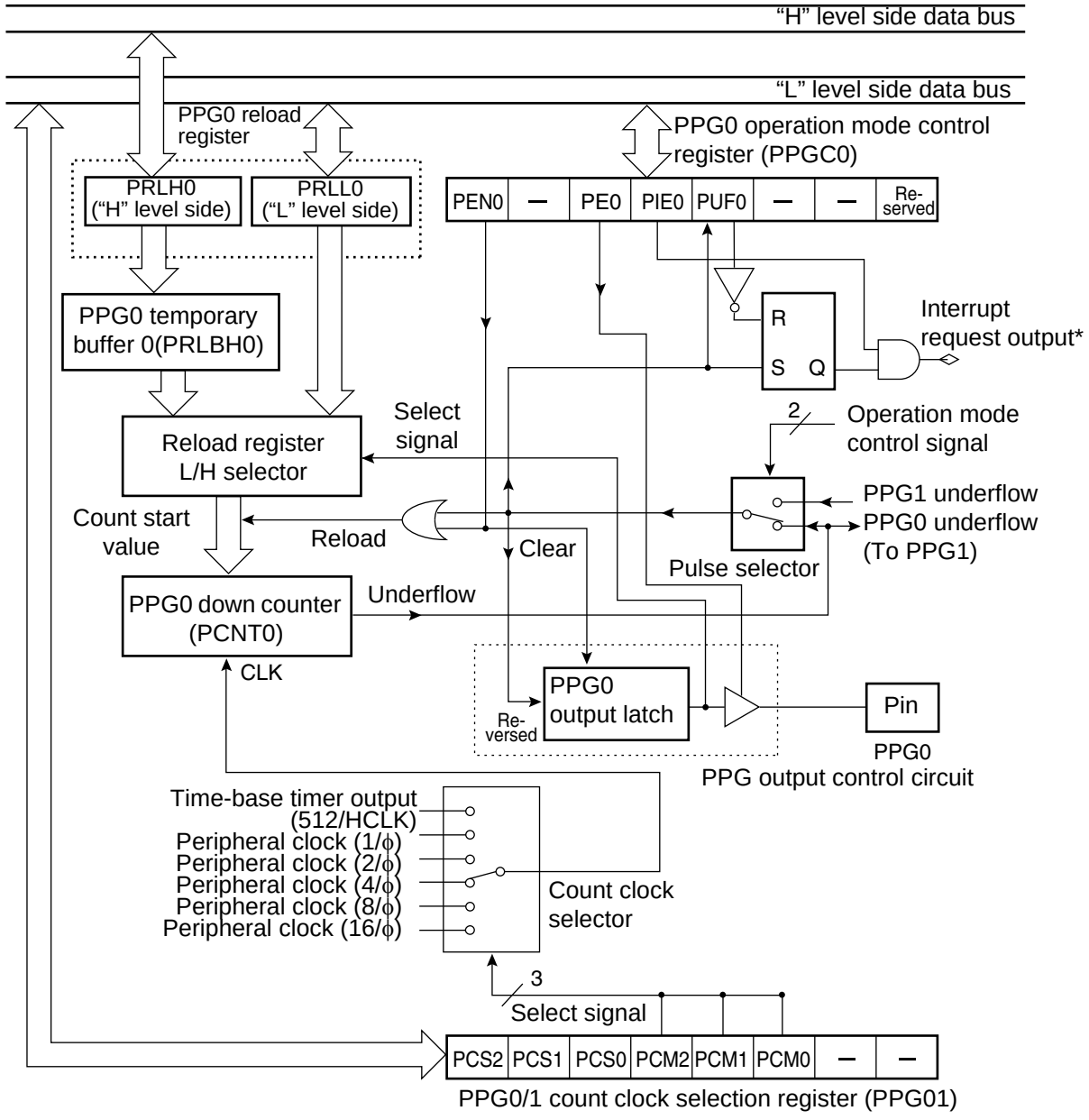
MB90385 series device has two 8/16-bit built-in PPG timers. This section describes functions of PPG0/1. PPG2/3 have the same functions as those of PPG0/1.

Functions of 8/16-bit PPG Timer

The 8/16-bit PPG timer is composed of four 8-bit reload register (PRLH0/PRLL0, PRLH1/PRLL1) and two PPG down counters (PCNT0, PCNT1).

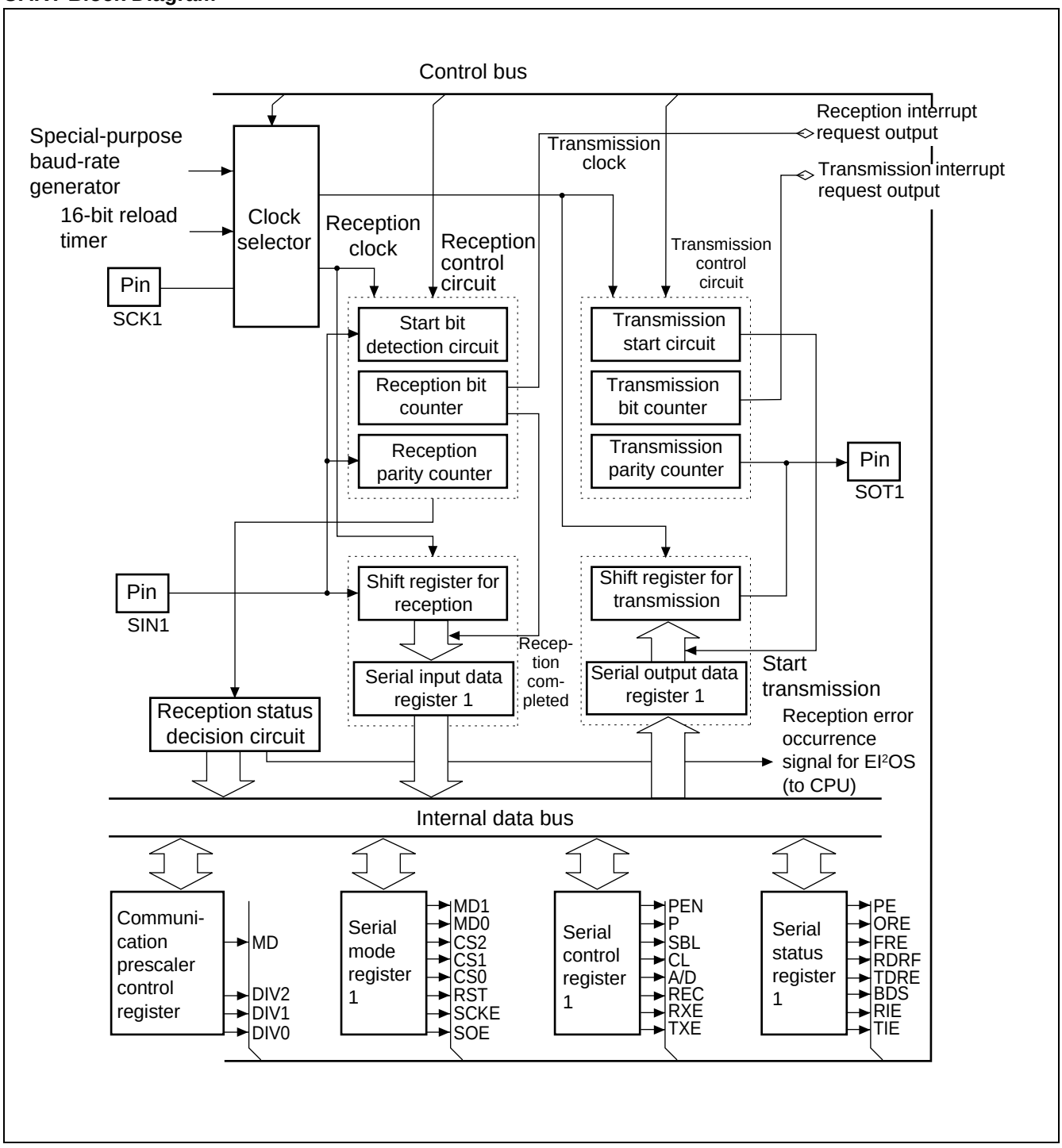
- Widths of “H” and “L” in output pulse are specifiable independently. Cycle and duty factor of output pulse is specifiable arbitrarily.
- Count clock is selectable among 6 internal clocks.
- The timer is usable as an interval timer, by generating interrupt requests for each interval.
- The time is usable as a D/A converter, with an external circuit.

8/16-bit PPG Timer 0 Block Diagram

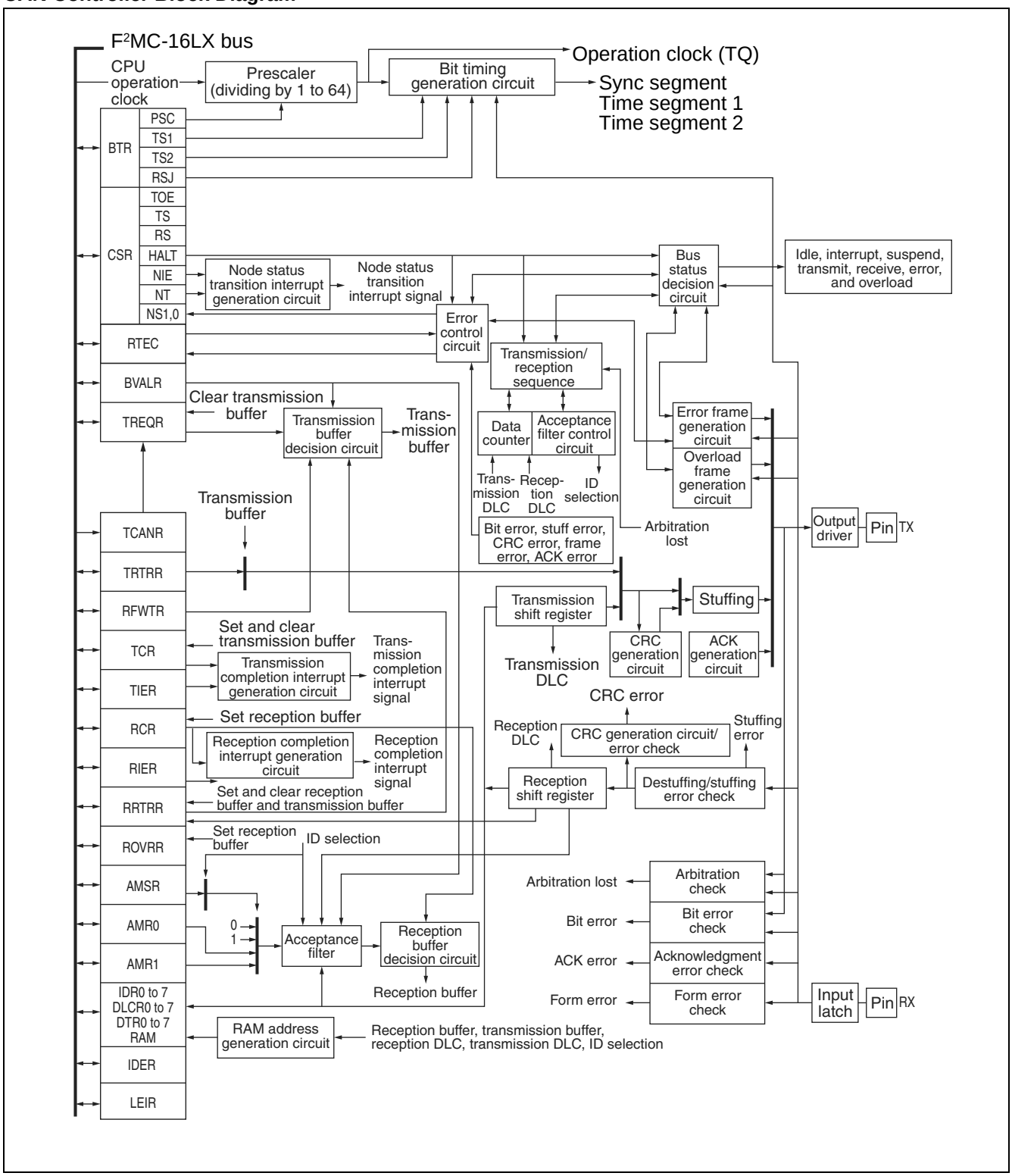


– : Undefined
Reserved: Reserved bit
HCLK : Oscillation clock frequency
ϕ : Machine clock frequency
* : Interrupt output of 8/16-bit PPG timer 0 is incorporated into one by the OR circuit against interrupt output of 8/16-bit PPG timer 1.

UART Block Diagram



CAN Controller Block Diagram



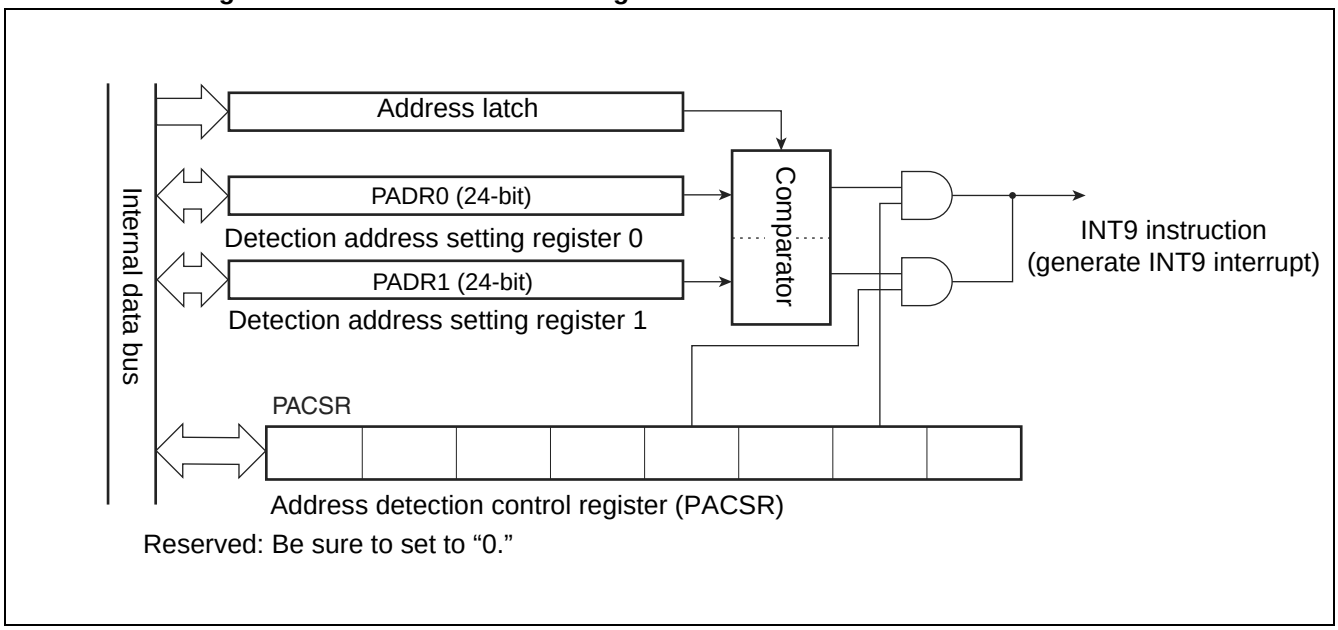
12.13 Address Matching Detection Function Outline

The address matching detection function checks if an address of an instruction to be processed next to a currently-processed instruction is identical with an address specified in the detection address register. If the addresses match with each other, an instruction to be processed next in program is forcibly replaced with INT9 instruction, and process branches to the interrupt process program. Using INT9 interrupt, this function is available for correcting program by batch processing.

Address Matching Detection Function Outline

- An address of an instruction to be processed next to a currently-processed instruction of the program is always retained in an address latch via internal data bus. By the address matching detection function, the address value retained in the address latch is always compared with an address specified in detection address setting register. If the compared address values match with each other, an instruction to be processed next by CPU is forcibly replaced with INT9 instruction, and an interrupt process program is executed.
- Two detection address setting registers are provided (PADR0 and PADR1), and each register is provided with interrupt permission bit. Generation of interrupt, which is caused by address matching between the address retained in address latch and the address specified in address setting register, is permitted and prohibited on a register-by-register basis.

Address Matching Detection Function Block Diagram



- Address latch

  Retains address value output to internal data bus.

- Address detection control register (PACSR)

  Specifies if interrupt is permitted or prohibited when addresses match with each other.

- Detection address setting (PADR0, PADR1)

  Specifies addresses to be compared with values in address latch.

12.15 512 Kbit Flash Memory Outline

The following three methods are provided for data writing and deleting on Flash memory:

1. Parallel writer
2. Serial special-purpose writer
3. Writing/deleting by program execution

This section describes “3. Writing/deleting by program execution.”

512 Kbit Flash Memory Outline

The 512 Kbit Flash memory is allocated on FF_H bank of CPU memory map. Using the function of Flash memory interface circuit, the memory allows read access and program access from CPU.

Writing/deleting on Flash memory is performed by instruction from CPU via Flash memory interface. Because rewriting is allowed on mounted memory, modifying program and data is performed efficiently.

Features of 512 Kbit Flash Memory

- 128 K words x 8 bits/64 K words x 16 bits (16 K + 8 K + 8 K + 32 K) sector configuration
- Automatic program algorithm (Embedded Algorithm: Similar to MBM29LV200.)
- Built-in deletion pause/deletion resume function
- Detection of completed writing/deleting by data polling and toggle bits.
- Detection of completed writing/deleting by CPU interrupt.
- Deletion is allowed on a sector-by-sector basis (sectors are combined freely).
- Number of writing/deleting operations (minimum): 10,000 times
- Sector protection
- Expanded sector protection
- Temporaly sector unprotection

Note: A function of reading manufacture code and device code is not provided. These codes are not accessible by command either.

Flash Memory Writing/Deleting

- Writing and reading data is not allowed simultaneously on the Flash memory.
- Data writing and deleting on the Flash memory is performed by the processes as follows: Make a copy of program on Flash memory onto RAM. Then, execute the program copied on the RAM.

List of Registers and Reset Values in Flash Memory

Flash memory control status register (FMCS)

bit	7	6	5	4	3	2	1	0
	0	0	0	X	0	0	0	0

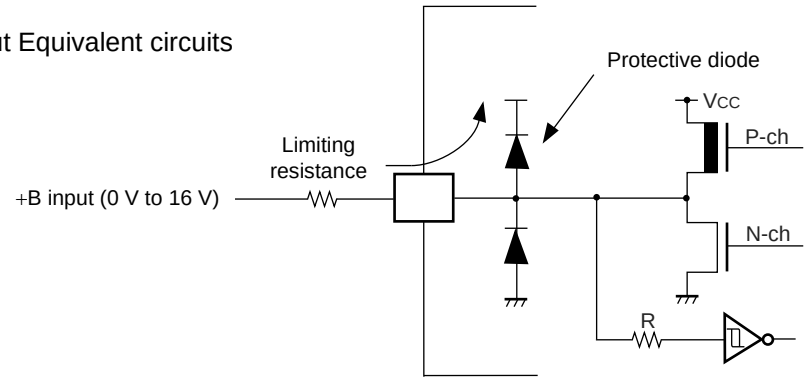
× : Undefined

Sector Configuration

For access from CPU, SA0 to SA3 are allocated in FF bank register.

- Use within recommended operating conditions.
- Use at DC voltage (current).
- The +B signal should always be applied a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the +B input pin open.
- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
- Sample recommended circuits:

• Input/Output Equivalent circuits



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

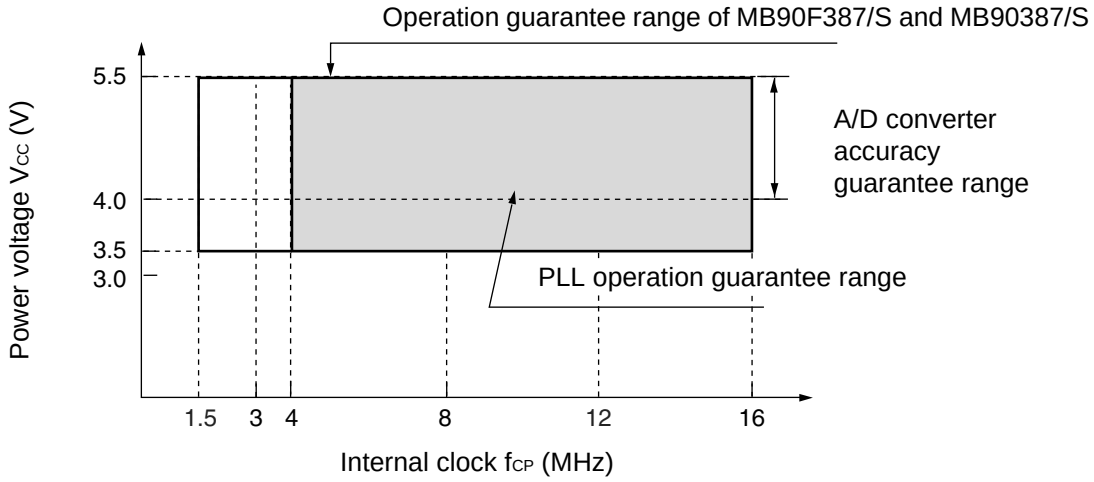
13.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

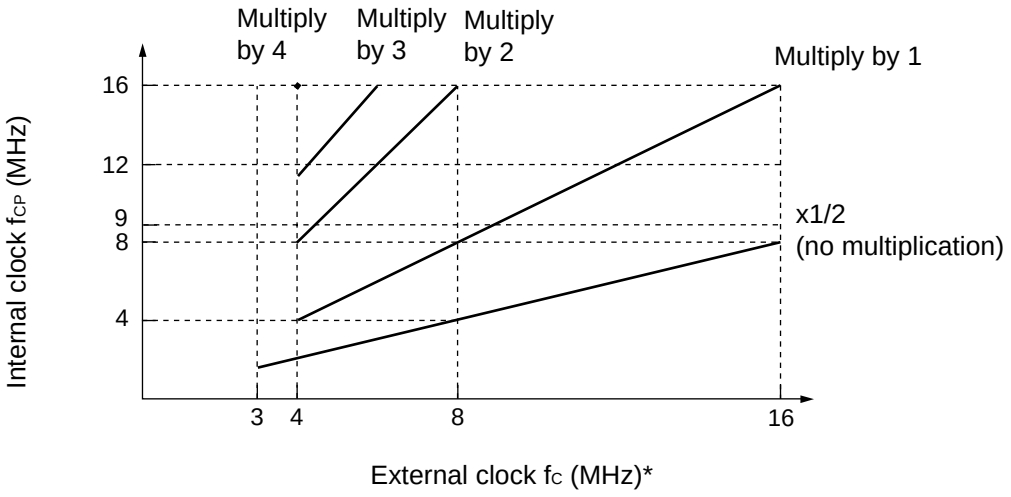
Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IHS}	CMOS hysteresis input pin	—	0.8 V_{CC}	—	V_{CC} + 0.3	V	
	V_{IHM}	MD input pin	—	V_{CC} – 0.3	—	V_{CC} + 0.3	V	
"L" level input voltage	V_{ILS}	CMOS hysteresis input pin	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	
	V_{ILM}	MD input pin	—	V_{SS} – 0.3	—	V_{SS} + 0.3	V	
"H" level output voltage	V_{OH1}	Pins other than P14 to P17	V_{CC} = 4.5 V, I_{OH} = –4.0 mA	V_{CC} – 0.5	—	—	V	
	V_{OH2}	P14 to P17	V_{CC} = 4.5 V, I_{OH} = –14.0 mA	V_{CC} – 0.5	—	—	V	
"L" level output voltage	V_{OL1}	Pins other than P14 to P17	V_{CC} = 4.5 V, I_{OL} = 4.0 mA	—	—	0.4	V	
	V_{OL2}	P14 to P17	V_{CC} = 4.5 V, I_{OL} = 20.0 mA	—	—	0.4	V	
Input leak current	I_{IL}	All input pins	V_{CC} = 5.5 V, V_{SS} < V_I < V_{CC}	–5	—	+5	µA	
Power supply current*	I_{CC}	V_{CC}	V_{CC} = 5.0 V, Internally operating at 16 MHz, normal operation.	—	25	30	mA	
			V_{CC} = 5.0 V, Internally operating at 16 MHz, writing on Flash memory.	—	45	50	mA	MB90F387/S
			V_{CC} = 5.0 V, Internally operating at 16 MHz, deleting on Flash memory.	—	45	50	mA	MB90F387/S
	I_{CCS}		V_{CC} = 5.0 V, Internally operating at 16 MHz, sleeping.	—	8	12	mA	
	I_{CTS}		V_{CC} = 5.0 V, Internally operating at 2 MHz, transition from main clock mode, in time-base timer mode.	—	0.75	1.0	mA	MB90F387/S
					0.2	0.35		MB90387/S

• PLL operation guarantee range

Relation between internal operation clock frequency and power supply voltage



Relation among external clock frequency and internal clock frequency

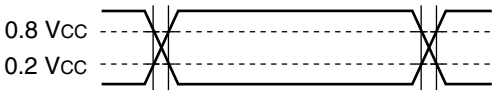


*: fc is 8 MHz at maximum when crystal or ceramic resonator circuit is used.

Rating values of alternating current is defined by the measurement reference voltage values shown below:

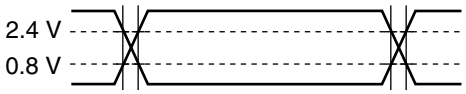
- Input signal waveform

Hysteresis input pin



- Output signal waveform

Output pin



13.4.2 Reset Input Timing

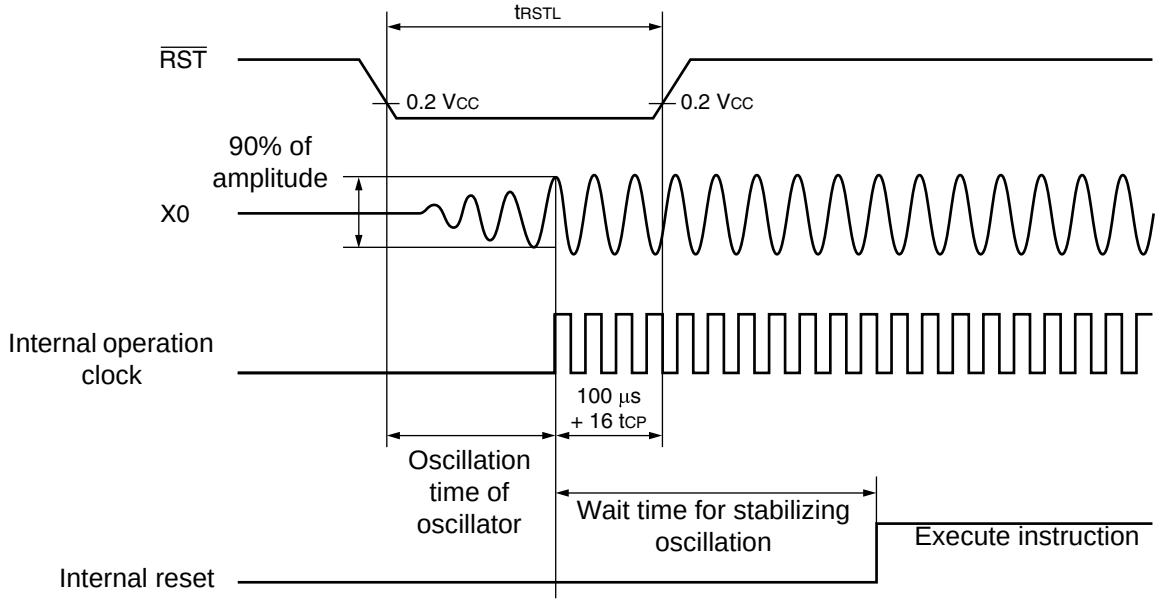
Parameter	Symbol	Pin Name	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	RST	16 t_{CP}*3	–	ns	Normal operation
			Oscillation time of oscillator*1 + 100 μs + 16 t_{CP}*3	–	–	In sub clock*2, sub sleep*2, watch*2 and stop mode
			100	–	μs	In timebase timer

*1: Oscillation time of oscillator is time that the amplitude reached the 90%. In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between hundreds of μs to several ms. In the external clock, the oscillation time is 0 ms.

*2: Except for MB90F387S and MB90387S.

*3: Refer to "(1) Clock timing" ratings for t_{CP} (internal operation clock cycle time).

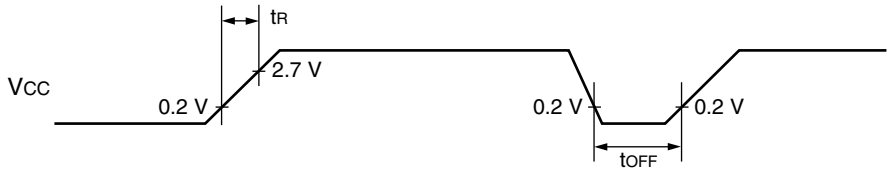
- In sub clock, sub sleep, watch and stop mode



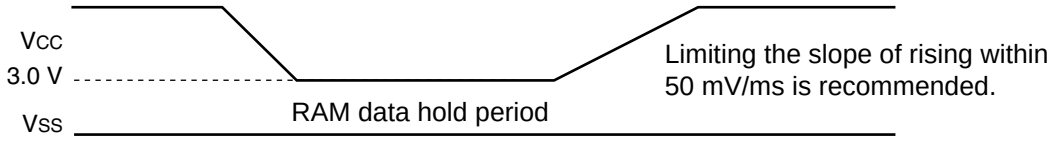
13.4.3 Power-on Reset

(V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

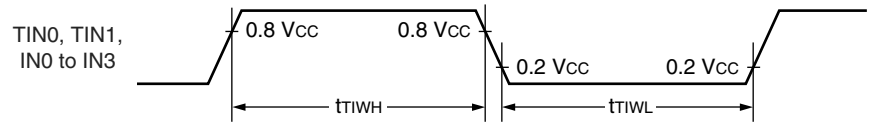
Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Power supply rise time	t_R	V_{CC}	–	0.05	30	ms	
Power supply shutdown time	t_{OFF}	V_{CC}		1	–	ms	Waiting time until power-on



Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, raise the power smoothly by suppressing variation of voltages as shown below. When raising the power, do not use PLL clock. However, if voltage drop is 1V/s or less, use of PLL clock is allowed during operation.



• Timer input timing



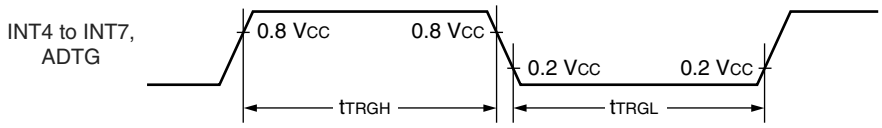
13.4.6 Trigger Input Timing

(V_{CC} = 4.5 V to 5.5 V, V_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

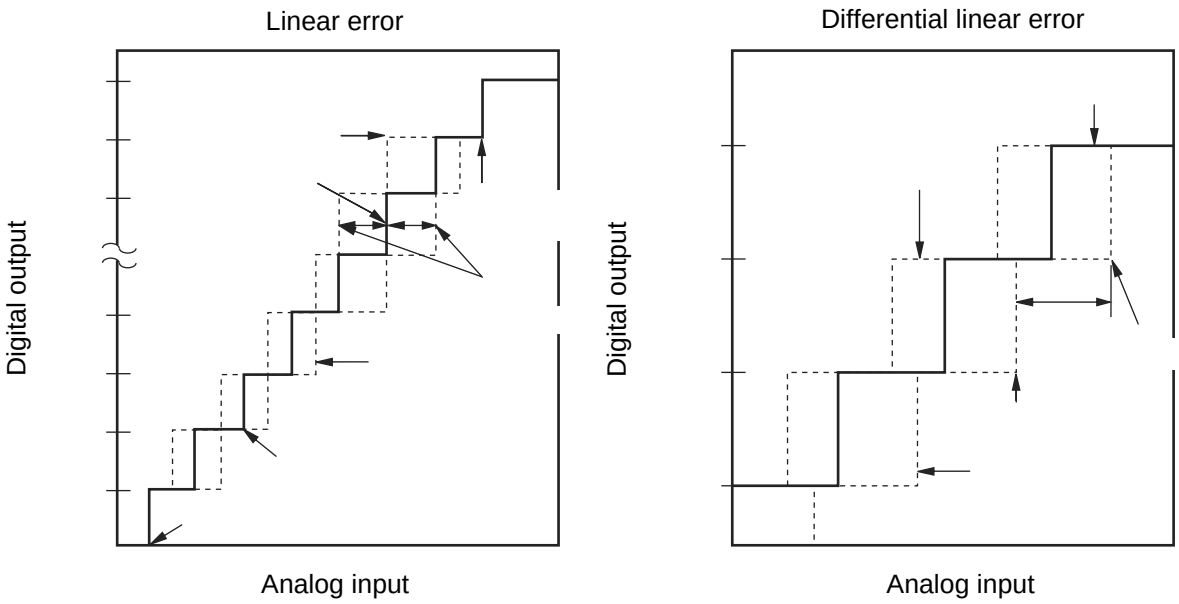
Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH} t_{TRGL}	INT4 to INT7, ADTG	–	5 t_{CP} *	–	ns	

*: Refer to Clock Timing ratings for t_{CP} (internal operation clock cycle time).

• Trigger input timing



(Continued)



$$\text{Linear error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linear error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

V_{OT}: Voltage at which digital output transits from “000_H” to “001_H.”
V_{FST}: Voltage at which digital output transits from “$3FE_H$” to “$3FF_H$.”

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